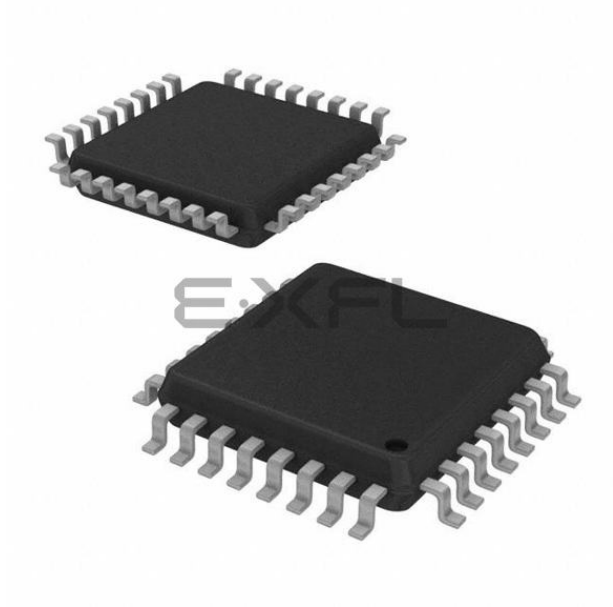

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I²C), SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	8
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 4x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f007-gqr

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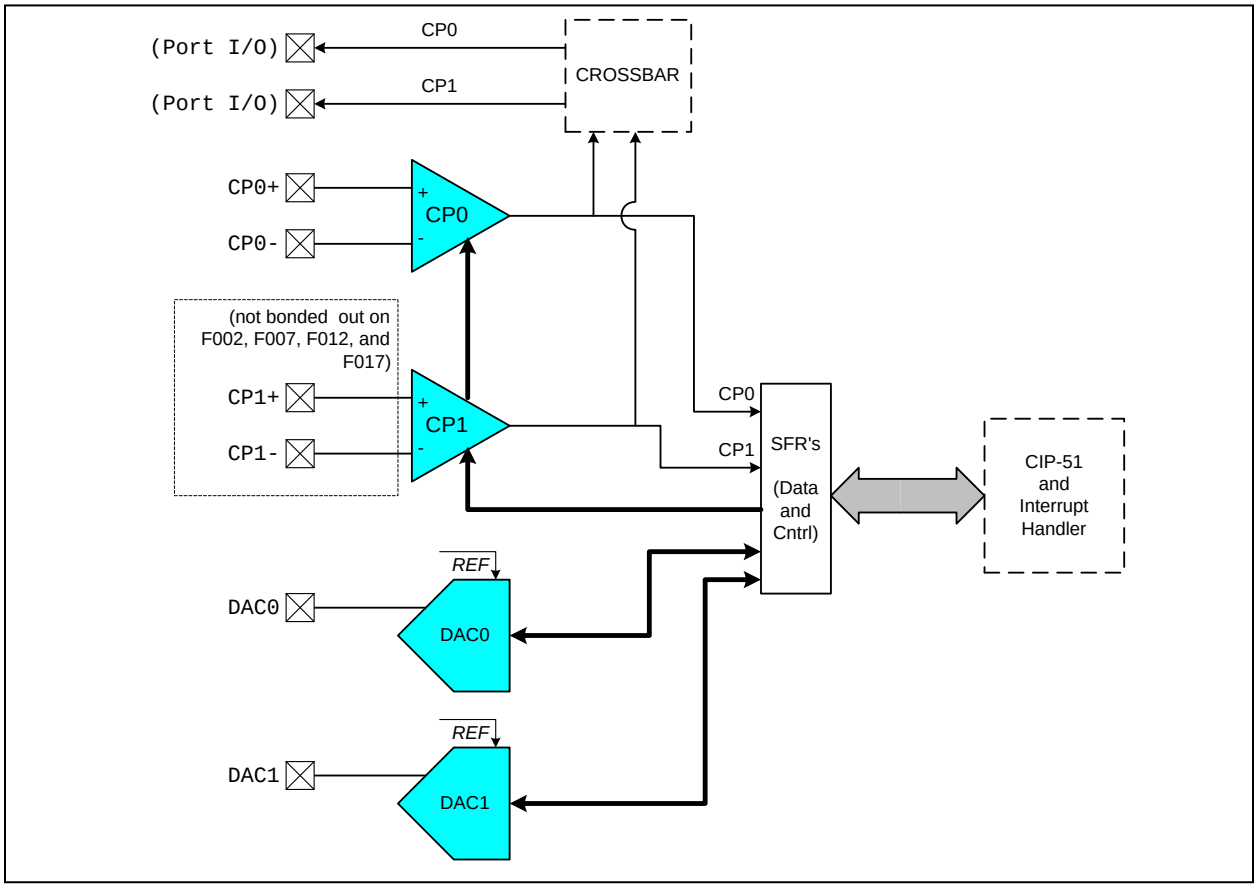
1.8. Comparators and DACs

The C8051F000 MCU Family has two 12-bit DACs and two comparators on chip (the second comparator, CP1, is not bonded out on the F002, F007, F012, and F017). The MCU data and control interface to each comparator and DAC is via the Special Function Registers. The MCU can place any DAC or comparator in low power shutdown mode.

The comparators have software programmable hysteresis. Each comparator can generate an interrupt on its rising edge, falling edge, or both. The comparators' output state can also be polled in software. These interrupts are capable of waking up the MCU from idle mode. The comparator outputs can be programmed to appear on the Port I/O pins via the Crossbar.

The DACs are voltage output mode and use the same voltage reference as the ADC. They are especially useful as references for the comparators or offsets for the differential inputs of the ADC.

Figure 1.11. Comparator and DAC Diagram

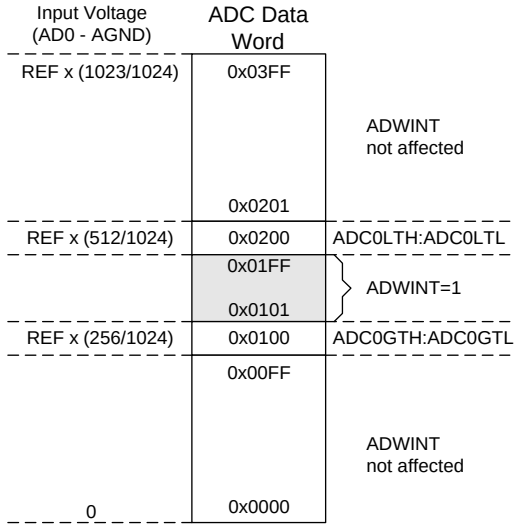


4. PINOUT AND PACKAGE DEFINITIONS

Table 4.1. Pin Definitions

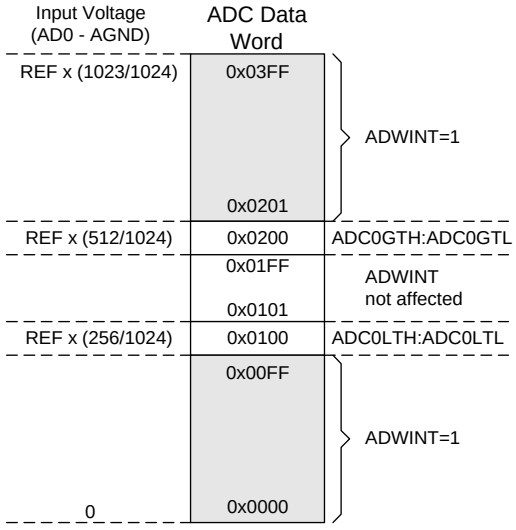
Name	Pin Numbers			Type	Description
	F000 F005 F010 F015	F001 F006 F011 F016	F002 F007 F012 F017		
VDD	31, 40, 62	23, 32	18, 20		Digital Voltage Supply.
DGND	30, 41, 61	22, 33, 27, 19	17, 21		Digital Ground.
AV+	16, 17	13, 43	9, 29		Positive Analog Voltage Supply.
AGND	5, 15	44, 12	8, 30		Analog Ground.
TCK	22	18	14	D In	JTAG Test Clock with internal pull-up.
TMS	21	17	13	D In	JTAG Test-Mode Select with internal pull-up.
TDI	28	20	15	D In	JTAG Test Data Input with internal pull-up. TDI is latched on a rising edge of TCK.
TDO	29	21	16	D Out	JTAG Test Data Output with internal pull-up. Data is shifted out on TDO on the falling edge of TCK. TDO output is a tri-state driver.
XTAL1	18	14	10	A In	Crystal Input. This pin is the return for the internal oscillator circuit for a crystal or ceramic resonator. For a precision internal clock, connect a crystal or ceramic resonator from XTAL1 to XTAL2. If overdriven by an external CMOS clock, this becomes the system clock.
XTAL2	19	15	11	A Out	Crystal Output. This pin is the excitation driver for a crystal or ceramic resonator.
/RST	20	16	12	D I/O	Chip Reset. Open-drain output of internal Voltage Supply monitor. Is driven low when VDD is < 2.7V. An external source can force a system reset by driving this pin low.
VREF	6	3	3	A I/O	Voltage Reference. When configured as an input, this pin is the voltage reference for the MCU. Otherwise, the internal reference drives this pin.
CP0+	4	2	2	A In	Comparator 0 Non-Inverting Input.
CP0-	3	1	1	A In	Comparator 0 Inverting Input.
CP1+	2	45		A In	Comparator 1 Non-Inverting Input.
CP1-	1	46		A In	Comparator 1 Inverting Input.
DAC0	64	48	32	A Out	Digital to Analog Converter Output 0. The DAC0 voltage output. (See Section 7 DAC Specification for complete description).
DAC1	63	47	31	A Out	Digital to Analog Converter Output 1. The DAC1 voltage output. (See Section 7 DAC Specification for complete description).
AIN0	7	4	4	A In	Analog Mux Channel Input 0. (See ADC Specification for complete description).
AIN1	8	5	5	A In	Analog Mux Channel Input 1. (See ADC Specification for complete description).
AIN2	9	6	6	A In	Analog Mux Channel Input 2. (See ADC Specification for complete description).
AIN3	10	7	7	A In	Analog Mux Channel Input 3. (See ADC Specification for complete description).
AIN4	11	8		A In	Analog Mux Channel Input 4. (See ADC Specification for complete description).
AIN5	12	9		A In	Analog Mux Channel Input 5. (See ADC Specification for complete description).

Figure 6.14. 10-Bit ADC Window Interrupt Examples, Right Justified Data



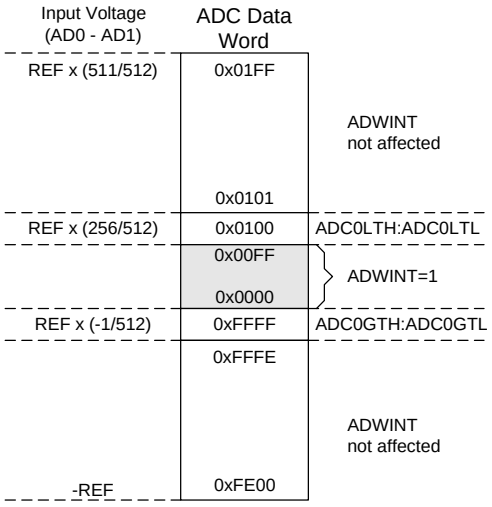
Given:
AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 0,
ADC0LTH:ADC0LTL = 0x0200,
ADC0GTH:ADC0GTL = 0x0100.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x0200 and > 0x0100.



Given:
AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 0,
ADC0LTH:ADC0LTL = 0x0100,
ADC0GTH:ADC0GTL = 0x0200.

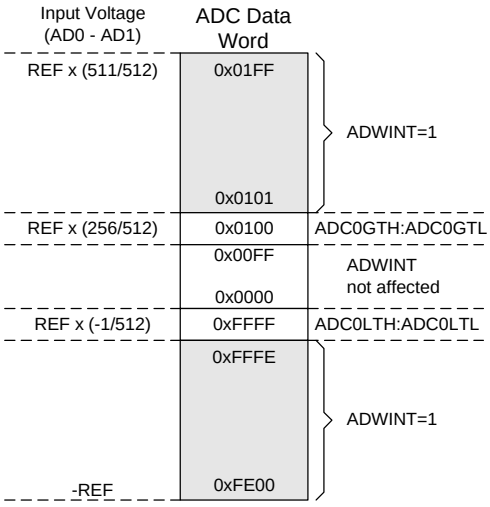
An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x0100 or > 0x0200.



Given:

AMX0SL = 0x00, AMX0CF = 0x01, ADLJST = 0,
ADC0LTH:ADC0LTL = 0x0100,
ADC0GTH:ADC0GTL = 0xFFFF.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x0100 and > 0xFFFF. (Two's Complement math, 0xFFFF = -1.)



Given:

AMX0SL = 0x00, AMX0CF = 0x01, ADLJST = 0,
ADC0LTH:ADC0LTH = 0xFFFF,
ADC0GTH:ADC0GTL = 0x0100.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0xFFFF or > 0x0100. (Two's Complement math, 0xFFFF = -1.)

Figure 7.2. DAC0H: DAC0 High Byte Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xD3

Bits7-0: DAC0 Data Word Most Significant Byte.

Figure 7.3. DAC0L: DAC0 Low Byte Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xD2

Bits7-0: DAC0 Data Word Least Significant Byte.

Figure 7.4. DAC0CN: DAC0 Control Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
DAC0EN	-	-	-	-	DAC0DF2	DAC0DF1	DAC0DF0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xD4

Bit7: DAC0EN: DAC0 Enable Bit
0: DAC0 Disabled. DAC0 Output pin is disabled; DAC0 is in low power shutdown mode.
1: DAC0 Enabled. DAC0 Output is pin active; DAC0 is operational.
Bits6-3: UNUSED. Read = 0000b; Write = don't care
Bits2-0: DAC0DF2-0: DAC0 Data Format Bits
000: The most significant nybble of the DAC0 Data Word is in DAC0H[3:0], while the least significant byte is in DAC0L.

DAC0H								DAC0L							
				MSB											LSB

001: The most significant 5-bits of the DAC0 Data Word is in DAC0H[4:0], while the least significant 7-bits is in DAC0L[7:1].

DAC0H								DAC0L							
			MSB											LSB	

010: The most significant 6-bits of the DAC0 Data Word is in DAC0H[5:0], while the least significant 6-bits is in DAC0L[7:2].

DAC0H								DAC0L							
		MSB											LSB		

011: The most significant 7-bits of the DAC0 Data Word is in DAC0H[6:0], while the least significant 5-bits is in DAC0L[7:3].

DAC0H								DAC0L							
	MSB											LSB			

1xx: The most significant byte of the DAC0 Data Word is in DAC0H, while the least significant nybble is in DAC0L[7:4].

DAC0H								DAC0L							
MSB											LSB				

Table 7.1. DAC Electrical Characteristics

VDD = 3.0V, AV+ = 3.0V, REF = 2.40V (REFBE=0), No Output Load unless otherwise specified.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
STATIC PERFORMANCE					
Resolution			12		bits
Integral Nonlinearity	For Data Word Range 0x014 to 0xFEB		±2		LSB
Differential Nonlinearity	Guaranteed Monotonic (codes 0x014 to 0xFEB)			±1	LSB
Output Noise	No Output Filter 100kHz Output Filter 10kHz Output Filter		250 128 41		µVrms
Offset Error	Data Word = 0x014		±3	±30	mV
Offset Tempco			6		ppm/°C
Full-Scale Error			±20	±60	mV
Full-Scale Error Tempco			10		ppm/°C
VDD Power-Supply Rejection Ratio			-60		dB
Output Impedance in Shutdown Mode	DACnEN=0		100		kΩ
Output Current			±300		µA
Output Short Circuit Current	Data Word = 0xFFF		15		mA
DYNAMIC PERFORMANCE					
Voltage Output Slew Rate	Load = 40pF		0.44		V/µs
Output Settling Time To ½ LSB	Load = 40pF, Output swing from code 0xFFF to 0x014		10		µs
Output Voltage Swing		0		REF-1LSB	V
Startup Time	DAC Enable asserted		10		µs
ANALOG OUTPUTS					
Load Regulation	I_L = 0.01mA to 0.3mA at code 0xFFF		60		ppm
CURRENT CONSUMPTION (each DAC)					
Power Supply Current (AV+ supplied to DAC)	Data Word = 0x7FF		110	400	µA

10. CIP-51 CPU

The MCUs' system CPU is the CIP-51. The CIP-51 is fully compatible with the MCS-51™ instruction set. Standard 803x/805x assemblers and compilers can be used to develop software. The MCU family has a superset of all the peripherals included with a standard 8051. Included are four 16-bit counter/timers (see description in Section 19), a full-duplex UART (see description in Section 18), 256 bytes of internal RAM, 128 byte Special Function Register (SFR) address space (see Section 10.3), and four byte-wide I/O Ports (see description in Section 14). The CIP-51 also includes on-chip debug hardware (see description in Section 21), and interfaces directly with the MCUs' analog and digital subsystems providing a complete data acquisition or control-system solution in a single integrated circuit.

Features

The CIP-51 Microcontroller core implements the standard 8051 organization and peripherals as well as additional custom peripherals and functions to extend its capability (see Figure 10.1 for a block diagram). The CIP-51 includes the following features:

- Fully Compatible with MCS-51 Instruction Set
- 25 MIPS Peak Throughput with 25MHz Clock
- 0 to 25MHz Clock Frequency (on 'F0x5/6/7)
- Four Byte-Wide I/O Ports
- Extended Interrupt Handler
- Reset Input
- Power Management Modes
- On-chip Debug Circuitry
- Program and Data Memory Security

Figure 10.1. CIP-51 Block Diagram

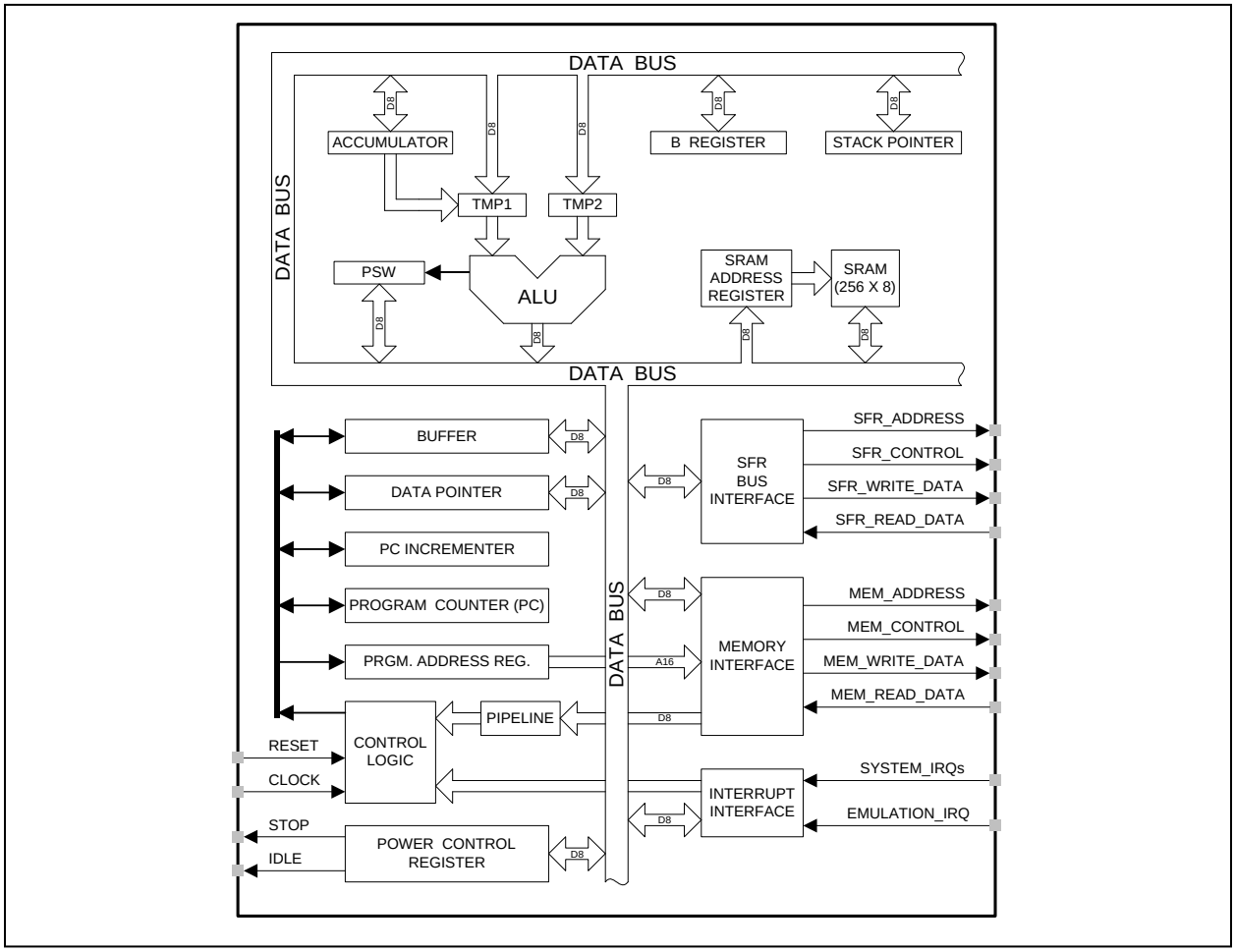


Figure 10.6. PSW: Program Status Word

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
CY	AC	F0	RS1	RS0	OV	F1	PARITY	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xD0

Bit7: CY: Carry Flag.
This bit is set when the last arithmetic operation results in a carry (addition) or a borrow (subtraction). It is cleared to 0 by all other arithmetic operations.

Bit6: AC: Auxiliary Carry Flag.
This bit is set when the last arithmetic operation results in a carry into (addition) or a borrow from (subtraction) the high order nibble. It is cleared to 0 by all other arithmetic operations.

Bit5: F0: User Flag 0.
This is a bit-addressable, general purpose flag for use under software control.

Bits4-3: RS1-RS0: Register Bank Select.
These bits select which register bank is used during register accesses.

RS1	RS0	Register Bank	Address
0	0	0	0x00-0x07
0	1	1	0x08-0x0F
1	0	2	0x10-0x17
1	1	3	0x18-0x1F

Note: Any instruction which changes the RS1-RS0 bits must not be immediately followed by the “MOV Rn, A” instruction.

Bit2: OV: Overflow Flag.
This bit is set to 1 under the following circumstances:

- An ADD, ADDC, or SUBB instruction causes a sign-change overflow.
- A MUL instruction results in an overflow (result is greater than 255) .
- A DIV instruction causes a divide-by-zero condition.

The OV bit is cleared to 0 by the ADD, ADDC, SUBB, MUL, and DIV instructions in all other cases.

Bit1: F1: User Flag 1.
This is a bit-addressable, general purpose flag for use under software control.

Bit0: PARITY: Parity Flag.
(Read only)
This bit is set to 1 if the sum of the eight bits in the accumulator is odd and cleared if the sum is even.

Figure 10.12. EIE2: Extended Interrupt Enable 2

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
EXVLD	-	EX7	EX6	EX5	EX4	EADC0	ET3	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xE7

Bit7: EXVLD: Enable External Clock Source Valid (XTLVLD) Interrupt.
This bit sets the masking of the XTLVLD interrupt.
0: Disable all XTLVLD interrupts.
1: Enable interrupt requests generated by the XTLVLD flag (OSCXCN.7)

Bit6: Reserved. Must Write 0. Reads 0.

Bit5: EX7: Enable External Interrupt 7.
This bit sets the masking of External Interrupt 7.
0: Disable External Interrupt 7.
1: Enable interrupt requests generated by the External Interrupt 7 input pin.

Bit4: EX6: Enable External Interrupt 6.
This bit sets the masking of External Interrupt 6.
0: Disable External Interrupt 6.
1: Enable interrupt requests generated by the External Interrupt 6 input pin.

Bit3: EX5: Enable External Interrupt 5.
This bit sets the masking of External Interrupt 5.
0: Disable External Interrupt 5.
1: Enable interrupt requests generated by the External Interrupt 5 input pin.

Bit2: EX4: Enable External Interrupt 4.
This bit sets the masking of External Interrupt 4.
0: Disable External Interrupt 4.
1: Enable interrupt requests generated by the External Interrupt 4 input pin.

Bit1: EADC0: Enable ADC0 End of Conversion Interrupt.
This bit sets the masking of the ADC0 End of Conversion Interrupt.
0: Disable ADC0 Conversion Interrupt.
1: Enable interrupt requests generated by the ADC0 Conversion Interrupt.

Bit0: ET3: Enable Timer 3 Interrupt.
This bit sets the masking of the Timer 3 interrupt.
0: Disable all Timer 3 interrupts.
1: Enable interrupt requests generated by the TF3 flag (TMR3CN.7)

Figure 10.13. EIP1: Extended Interrupt Priority 1

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PCP1R	PCP1F	PCP0R	PCP0F	PPCA0	PWADC0	PSMB0	PSPI0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xF6

Bit7: PCP1R: Comparator 1 (CP1) Rising Interrupt Priority Control.
This bit sets the priority of the CP1 interrupt.
0: CP1 rising interrupt set to low priority level.
1: CP1 rising interrupt set to high priority level.

Bit6: PCP1F: Comparator 1 (CP1) Falling Interrupt Priority Control.
This bit sets the priority of the CP1 interrupt.
0: CP1 falling interrupt set to low priority level.
1: CP1 falling interrupt set to high priority level.

Bit5: PCP0R: Comparator 0 (CP0) Rising Interrupt Priority Control.
This bit sets the priority of the CP0 interrupt.
0: CP0 rising interrupt set to low priority level.
1: CP0 rising interrupt set to high priority level.

Bit4: PCP0F: Comparator 0 (CP0) Falling Interrupt Priority Control.
This bit sets the priority of the CP0 interrupt.
0: CP0 falling interrupt set to low priority level.
1: CP0 falling interrupt set to high priority level.

Bit3: PPCA0: Programmable Counter Array (PCA0) Interrupt Priority Control.
This bit sets the priority of the PCA0 interrupt.
0: PCA0 interrupt set to low priority level.
1: PCA0 interrupt set to high priority level.

Bit2: PWADC0: ADC0 Window Comparator Interrupt Priority Control.
This bit sets the priority of the ADC0 Window interrupt.
0: ADC0 Window interrupt set to low priority level.
1: ADC0 Window interrupt set to high priority level.

Bit1: PSMB0: SMBus 0 Interrupt Priority Control.
This bit sets the priority of the SMBus interrupt.
0: SMBus interrupt set to low priority level.
1: SMBus interrupt set to high priority level.

Bit0: PSPI0: Serial Peripheral Interface 0 Interrupt Priority Control.
This bit sets the priority of the SPI0 interrupt.
0: SPI0 interrupt set to low priority level.
1: SPI0 interrupt set to high priority level.

12. EXTERNAL RAM (C8051F005/06/07/15/16/17)

The C8051F005/06/07/15/16/17 MCUs include 2048 bytes of RAM mapped into the external data memory space. All of these address locations may be accessed using the external move instruction (MOVX) and the data pointer (DPTR), or using MOVX indirect addressing mode. If the MOVX instruction is used with an 8-bit address operand (such as @R1), then the high byte of the 16-bit address is provided by the External Memory Interface Control Register (EMI0CN as shown in Figure 12.1). **Note: the MOVX instruction is also used for writes to the Flash memory. See Section 11 for details. The MOVX instruction accesses XRAM by default (i.e. PSTCL.0 = 0).**

For any of the addressing modes the upper 5-bits of the 16-bit external data memory address word are "don't cares". As a result, the 2048-byte RAM is mapped modulo style over the entire 64k external data memory address range. For example, the XRAM byte at address 0x0000 is also at address 0x0800, 0x1000, 0x1800, 0x2000, etc. This is a useful feature when doing a linear memory fill, as the address pointer doesn't have to be reset when reaching the RAM block boundary.

Figure 12.1. EMI0CN: External Memory Interface Control

R	R	R	R	R	R/W	R/W	R/W	Reset Value
-	-	-	-	-	PGSEL2	PGSEL1	PGSEL0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xAF

Bits 7-3: Not Used – reads 00000b

Bits 2-0: PGSEL[2:0]: XRAM Page Select Bits

The XRAM Page Select Bits provide the high byte of the 16-bit external data memory address when using an 8-bit MOVX command, effectively selecting a 256-byte page of RAM. The upper 5-bits are "don't cares", so the 2k address blocks are repeated modulo over the entire 64k external data memory address space.

000: xxxxx000b
001: xxxxx001b
010: xxxxx010b
011: xxxxx011b
100: xxxxx100b
101: xxxxx101b
110: xxxxx110b
111: xxxxx111b

Figure 14.3. OSCXCN: External Oscillator Control Register

R	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
XTLVLD	XOSCMD2	XOSCMD1	XOSCMD0	-	XFCN2	XFCN1	XFCN0	00110000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xB1

Bit7: XTLVLD: Crystal Oscillator Valid Flag
(Valid only when XOSCMD = 1xx.)
0: Crystal Oscillator is unused or not yet stable
1: Crystal Oscillator is running and stable (should read 1ms after Crystal Oscillator is enabled to avoid transient condition).

Bits6-4: XOSCMD2-0: External Oscillator Mode Bits
00x: Off. XTAL1 pin is grounded internally.
010: System Clock from External CMOS Clock on XTAL1 pin.
011: System Clock from External CMOS Clock on XTAL1 pin divided by 2.
10x: RC/C Oscillator Mode with divide by 2 stage.
110: Crystal Oscillator Mode
111: Crystal Oscillator Mode with divide by 2 stage.

Bit3: RESERVED. Read = undefined, Write = don't care

Bits2-0: XFCN2-0: External Oscillator Frequency Control Bits
000-111: see table below

XFCN	Crystal (XOSCMD = 11x)	RC (XOSCMD = 10x)	C (XOSCMD = 10x)
000	f ≤ 12.5kHz	f ≤ 25kHz	K Factor = 0.44
001	12.5kHz < f ≤ 30.3kHz	25kHz < f ≤ 50kHz	K Factor = 1.4
010	30.35kHz < f ≤ 93.8kHz	50kHz < f ≤ 100kHz	K Factor = 4.4
011	93.8kHz < f ≤ 267kHz	100kHz < f ≤ 200kHz	K Factor = 13
100	267kHz < f ≤ 722kHz	200kHz < f ≤ 400kHz	K Factor = 38
101	722kHz < f ≤ 2.23MHz	400kHz < f ≤ 800kHz	K Factor = 100
110	2.23MHz < f ≤ 6.74MHz	800kHz < f ≤ 1.6MHz	K Factor = 420
111	f > 6.74MHz	1.6MHz < f ≤ 3.2MHz	K Factor = 1400

CRYSTAL MODE (Circuit from Figure 14.1, Option 1; XOSCMD = 11x)
Choose XFCN value to match the crystal or ceramic resonator frequency.

RC MODE (Circuit from Figure 14.1, Option 2; XOSCMD = 10x)
Choose oscillation frequency range where:
$f = 1.23(10^3) / (R * C)$, where
f = frequency of oscillation in MHz
C = capacitor value in pF
R = Pull-up resistor value in kΩ

C MODE (Circuit from Figure 14.1, Option 3; XOSCMD = 10x)
Choose K Factor (KF) for the oscillation frequency desired:
f = KF / (C * AV+), where
f = frequency of oscillation in MHz
C = capacitor value on XTAL1, XTAL2 pins in pF
AV+ = Analog Power Supply on MCU in volts

15. PORT INPUT/OUTPUT

The MCUs have a wide array of digital resources, which are available through four digital I/O ports, P0, P1, P2 and P3. Each of the pins on Ports 0, 1, and 2 can be defined as either its corresponding port I/O or one of the internal digital resources assigned as shown in Figure 15.1. The designer has complete control over which functions are assigned, limited only by the number of physical I/O pins available on the selected package (the C8051F000/05/10/15 have all four ports pinned out, the F001/06/11/16 have P0 and P1, and the F002/07/12/17 have P0). This resource assignment flexibility is achieved through the use of a Priority CrossBar Decoder. (Note that the state of a Port I/O pin can always be read in the corresponding Port latch regardless of the Crossbar settings).

The CrossBar assigns the selected internal digital resources to the I/O pins based on the Priority Decode Table 15.1. The registers XBR0, XBR1, and XBR2, defined in Figure 15.3, Figure 15.4, and Figure 15.5 are used to select an internal digital function or let an I/O pin default to being a Port I/O. The crossbar functions identically for each MCU, with the caveat that P2 is not pinned out on the F001/06/11/16, and both P1 and P2 are not pinned out on the F002/07/12/17. Digital resources assigned to port pins that are not pinned out cannot be accessed.

All Port I/Os are 5V tolerant (Refer to Figure 15.2 for the port cell circuit.) The Port I/O cells are configured as either push-pull or open-drain in the Port Configuration Registers (PRT0CF, PRT1CF, PRT2CF, PRT3CF). Complete Electrical Specifications for Port I/O are given in Table 15.2.

15.1. Priority Cross Bar Decoder

One of the design goals of this MCU family was to make the entire palette of digital resources available to the designer even on reduced pin count packages. The Priority CrossBar Decoder provides an elegant solution to the problem of connecting the internal digital resources to the physical I/O pins.

The Priority CrossBar Decode (Table 15.1) assigns a priority to each I/O function, starting at the top with the SMBus. As the table illustrates, when selected, its two signals will be assigned to Pin 0 and 1 of I/O Port 0. The decoder always fills I/O bits from LSB to MSB starting with Port 0, then Port 1, finishing if necessary with Port 2. If you choose not to use a resource, the next function down on the table will fill the priority slot. In this way it is possible to choose only the functions required by the design, making full use of the available I/O pins. Also, any extra Port I/O are grouped together for more convenient use in application code.

Registers XBR0, XBR1 and XBR2 are used to assign the digital I/O resources to the physical I/O Port pins. It is important to understand that when the SMBus, SPI Bus, or UART is selected, the crossbar assigns all pins associated with the selected bus. It would be impossible for instance to assign the RX pin from the UART function without also assigning the TX function. Standard Port I/Os appear contiguously after the prioritized functions have been assigned. For example, if you choose functions that take the first 14 Port I/O (P0.[7:0], P1.[5:0]), you would have 18 Port I/O left unused by the crossbar (P1.[7:6], P2 and P3).

15.2. Port I/O Initialization

Port I/O initialization is straightforward. Registers XBR0, XBR1 and XBR2 must be loaded with the appropriate values to select the digital I/O functions required by the design. Setting the XBARE bit in XBR2 to 1 enables the CrossBar. **Until the Crossbar is enabled, the external pins remain as standard Ports in input mode regardless of the XBRn Register settings.** For given XBRn Register settings, one can determine the I/O pin-out using the Priority Decode Table; as an alternative, the Code Configuration Wizard function of the IDE software will determine the Port I/O pin-assignments based on the XBRn Register settings.

The output driver characteristics of the I/O pins are defined using the Port Configuration Registers PRT0CF, PRT1CF, PRT2CF and PRT3CF (see Figure 15.7, Figure 15.9, Figure 15.12, and Figure 15.14). Each Port Output driver can be configured as either Open Drain or Push-Pull. This is required even for the digital resources selected in the XBRn registers and is not automatic. The only exception to this is the SMBus (SDA, SCL) and UART Receive (RX, when in mode 0) pins which are Open-drain regardless of the PRTnCF settings. When the WEAKPUD bit in XBR2 is 0, a weak pullup is enabled for all Port I/O configured as open-drain. WEAKPUD does

Figure 15.13. P3: Port3 Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
P3.7	P3.6	P3.5	P3.4	P3.3	P3.2	P3.1	P3.0	11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xB0

Bits7-0: P3.[7:0]
(Write)
0: Logic Low Output.
1: Logic High Output (high-impedance if corresponding PRT3CF.n bit = 0)
(Read)
0: P3.n is logic low.
1: P3.n is logic high.

Figure 15.14. PRT3CF: Port3 Configuration Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xA7

Bits7-0: PRT3CF.[7:0]: Output Configuration Bits for P3.7-P3.0 (respectively)
0: Corresponding P3.n Output mode is Open-Drain.
1: Corresponding P3.n Output mode is Push-Pull.

Table 15.2. Port I/O DC Electrical Characteristics

VDD = 2.7 to 3.6V, -40°C to +85°C unless otherwise specified.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	I_{OH} = -10uA, Port I/O push-pull I_{OH} = -3mA, Port I/O push-pull I_{OH} = -10mA, Port I/O push-pull	VDD – 0.1 VDD – 0.7	 VDD – 0.8		V
Output Low Voltage	I_{OL} = 10uA I_{OL} = 8.5mA I_{OL} = 25mA		 1.0	0.1 0.6	V
Input High Voltage		0.7 x VDD			V
Input Low Voltage				0.3 x VDD	V
Input Leakage Current	DGND < Port Pin < VDD, Pin Tri-state Weak Pull-up Off Weak Pull-up On		 30	 ±1	µA
Capacitive Loading			5		pF

17.4. SPI Special Function Registers

The SPI is accessed and controlled through four special function registers in the system controller: SPI0CN Control Register, SPI0DAT Data Register, SPI0CFG Configuration Register, and SPI0CKR Clock Rate Register. The four special function registers related to the operation of the SPI Bus are described in the following section.

Figure 17.5. SPI0CFG: SPI Configuration Register

R/W	R/W	R	R	R	R/W	R/W	R/W	Reset Value
CKPHA	CKPOL	BC2	BC1	BC0	SPIFRS2	SPIFRS1	SPIFRS0	00000111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x9A

Bit7: CKPHA: SPI Clock Phase.
This bit controls the SPI clock phase.
0: Data sampled on first edge of SCK period.
1: Data sampled on second edge of SCK period.

Bit6: CKPOL: SPI Clock Polarity.
This bit controls the SPI clock polarity.
0: SCK line low in idle state.
1: SCK line high in idle state.

Bits5-3: BC2-BC0: SPI Bit Count.
Indicates which of the up to 8 bits of the SPI word have been transmitted.

BC2-BC0			Bit Transmitted
0	0	0	Bit 0 (LSB)
0	0	1	Bit 1
0	1	0	Bit 2
0	1	1	Bit 3
1	0	0	Bit 4
1	0	1	Bit 5
1	1	0	Bit 6
1	1	1	Bit 7 (MSB)

Bits2-0: SPIFRS2-SPIFRS0: SPI Frame Size.
These three bits determine the number of bits to shift in/out of the SPI shift register during a data transfer in master mode. They are ignored in slave mode.

SPIFRS			Bits Shifted
0	0	0	1
0	0	1	2
0	1	0	3
0	1	1	4
1	0	0	5
1	0	1	6
1	1	0	7
1	1	1	8

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18.1. UART Operational Modes

The UART provides four operating modes (one synchronous and three asynchronous) selected by setting configuration bits in the SCON register. These four modes offer different baud rates and communication protocols. The four modes are summarized in Table 18.1 below. Detailed descriptions follow.

Table 18.1. UART Modes

Mode	Synchronization	Baud Clock	Data Bits	Start/Stop Bits
0	Synchronous	SYSCLK/12	8	None
1	Asynchronous	Timer 1 or Timer 2 Overflow	8	1 Start, 1 Stop
2	Asynchronous	SYSCLK/32 or SYSCLK/64	9	1 Start, 1 Stop
3	Asynchronous	Timer 1 or Timer 2 Overflow	9	1 Start, 1 Stop

18.1.1. Mode 0: Synchronous Mode

Mode 0 provides synchronous, half-duplex communication. Serial data is transmitted and received on the RX pin. The TX pin provides the shift clock for both transmit and receive. The MCU must be the master since it generates the shift clock for transmission in both directions (see the interconnect diagram in Figure 18.2).

Eight data bits are transmitted/received, LSB first (see the timing diagram in Figure 18.3). Data transmission begins when an instruction writes a data byte to the SBUF register. The TI Transmit Interrupt Flag (SCON.1) is set at the end of the eighth bit time. Data reception begins when the REN Receive Enable bit (SCON.4) is set to logic 1 and the RI Receive Interrupt Flag (SCON.0) is cleared. One cycle after the eighth bit is shifted in, the RI flag is set and reception stops until software clears the RI bit. An interrupt will occur if enabled when either TI or RI is set.

The Mode 0 baud rate is the system clock frequency divided by twelve. RX is forced to open-drain in mode 0, and an external pull-up will typically be required.

Figure 18.2. UART Mode 0 Interconnect

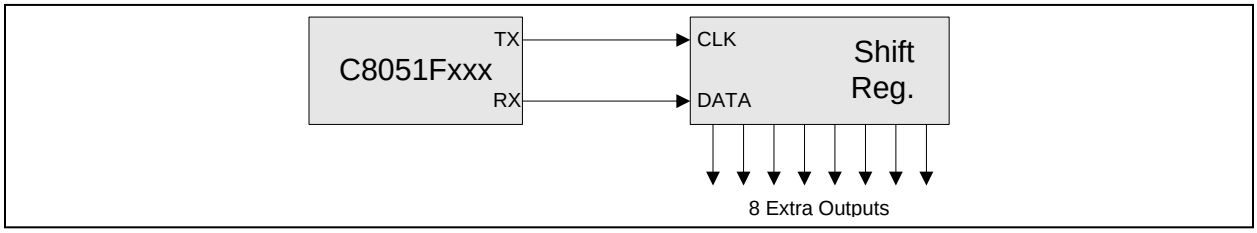
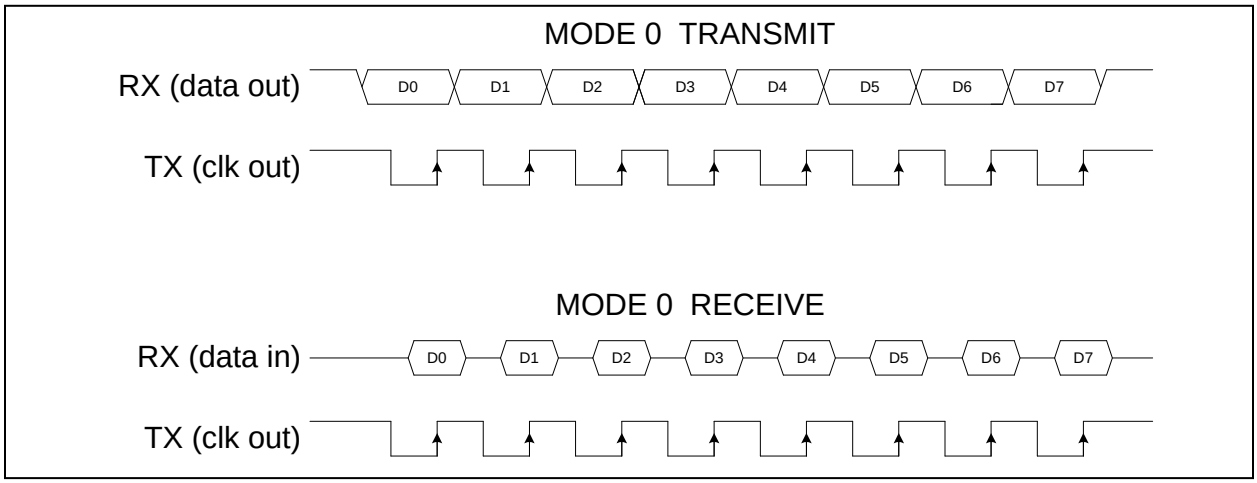


Figure 18.3. UART Mode 0 Timing Diagram



18.2. Multiprocessor Communications

Modes 2 and 3 support multiprocessor communication between a master processor and one or more slave processors by special use of the ninth data bit. When a master processor wants to transmit to one or more slaves, it first sends an address byte to select the target(s). An address byte differs from a data byte in that its ninth bit is logic 1; in a data byte, the ninth bit is always set to logic 0.

Setting the SM2 bit (SCON.5) of a slave processor configures its UART such that when a stop bit is received, the UART will generate an interrupt only if the ninth bit is logic one (RB8 = 1) signifying an address byte has been received. In the UART's interrupt handler, software will compare the received address with the slave's own assigned 8-bit address. If the addresses match, the slave will clear its SM2 bit to enable interrupts on the reception of the following data byte(s). Slaves that weren't addressed leave their SM2 bits set and do not generate interrupts on the reception of the following data bytes, thereby ignoring the data. Once the entire message is received, the addressed slave resets its SM2 bit to ignore all transmissions until it receives the next address byte.

Multiple addresses can be assigned to a single slave and/or a single address can be assigned to multiple slaves, thereby enabling "broadcast" transmissions to more than one slave simultaneously. The master processor can be configured to receive all transmissions or a protocol can be implemented such that the master/slave role is temporarily reversed to enable half-duplex transmission between the original master and slave(s).

Figure 18.7. UART Multi-Processor Mode Interconnect Diagram

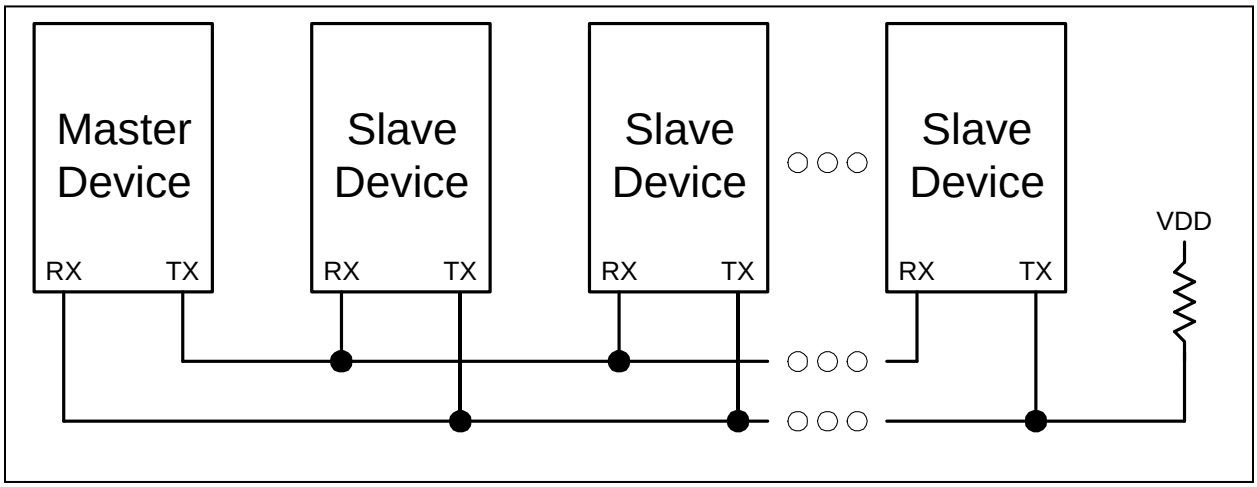


Figure 19.14. T2CON: Timer 2 Control Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2	CP/RL2	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
							(bit addressable)	0xC8

Bit7: TF2: Timer 2 Overflow Flag.
Set by hardware when Timer 2 overflows from 0xFFFF to 0x0000 or reload value. When the Timer 2 interrupt is enabled, setting this bit causes the CPU to vector to the Timer 2 interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software. TF2 will not be set when RCLK and/or TCLK are logic 1.

Bit6: EXF2: Timer 2 External Flag.
Set by hardware when either a capture or reload is caused by a high-to-low transition on the T2EX input pin and EXEN2 is logic 1. When the Timer 2 interrupt is enabled, setting this bit causes the CPU to vector to the Timer 2 Interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.

Bit5: RCLK: Receive Clock Flag.
Selects which timer is used for the UART's receive clock in modes 1 or 3.
0: Timer 1 overflows used for receive clock.
1: Timer 2 overflows used for receive clock.

Bit4: TCLK: Transmit Clock Flag.
Selects which timer is used for the UART's transmit clock in modes 1 or 3.
0: Timer 1 overflows used for transmit clock.
1: Timer 2 overflows used for transmit clock.

Bit3: EXEN2: Timer 2 External Enable.
Enables high-to-low transitions on T2EX to trigger captures or reloads when Timer 2 is not operating in Baud Rate Generator mode.
0: High-to-low transitions on T2EX ignored.
1: High-to-low transitions on T2EX cause a capture or reload.

Bit2: TR2: Timer 2 Run Control.
This bit enables/disables Timer 2.
0: Timer 2 disabled.
1: Timer 2 enabled.

Bit1: C/T2: Counter/Timer Select.
0: Timer Function: Timer 2 incremented by clock defined by T2M (CKCON.5).
1: Counter Function: Timer 2 incremented by high-to-low transitions on external input pin (T2).

Bit0: CP/RL2: Capture/Reload Select.
This bit selects whether Timer 2 functions in capture or auto-reload mode. EXEN2 must be logic 1 for high-to-low transitions on T2EX to be recognized and used to trigger captures or reloads. If RCLK or TCLK is set, this bit is ignored and Timer 2 will function in auto-reload mode.
0: Auto-reload on Timer 2 overflow or high-to-low transition at T2EX (EXEN2 = 1).
1: Capture on high-to-low transition at T2EX (EXEN2 = 1).

Figure 19.15. RCAP2L: Timer 2 Capture Register Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCA

Bits 7-0: RCAP2L: Timer 2 Capture Register Low Byte.
The RCAP2L register captures the low byte of Timer 2 when Timer 2 is configured in capture mode. When Timer 2 is configured in auto-reload mode, it holds the low byte of the reload value.

Figure 19.16. RCAP2H: Timer 2 Capture Register High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCB

Bits 7-0: RCAP2H: Timer 2 Capture Register High Byte.
The RCAP2H register captures the high byte of Timer 2 when Timer 2 is configured in capture mode. When Timer 2 is configured in auto-reload mode, it holds the high byte of the reload value.

Figure 19.17. TL2: Timer 2 Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCC

Bits 7-0: TL2: Timer 2 Low Byte.
The TL2 register contains the low byte of the 16-bit Timer 2.

Figure 19.18. TH2: Timer 2 High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCD

Bits 7-0: TH2: Timer 2 High Byte.
The TH2 register contains the high byte of the 16-bit Timer 2.

Figure 19.21. TMR3RLL: Timer 3 Reload Register Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x92

Bits 7-0: TMR3RLL: Timer 3 Reload Register Low Byte.
Timer 3 is configured as an auto-reload timer. This register holds the low byte of the reload value.

Figure 19.22. TMR3RLH: Timer 3 Reload Register High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x93

Bits 7-0: TMR3RLH: Timer 3 Reload Register High Byte.
Timer 3 is configured as an auto-reload timer. This register holds the high byte of the reload value.

Figure 19.23. TMR3L: Timer 3 Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x94

Bits 7-0: TMR3L: Timer 3 Low Byte.
The TMR3L register is the low byte of Timer 3.

Figure 19.24. TMR3H: Timer 3 High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x95

Bits 7-0: TMR3H: Timer 3 High Byte.
The TMR3H register is the high byte of Timer 3.